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**INFORMATION DISCLOSURE
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Form PTO-1449 (Modified)
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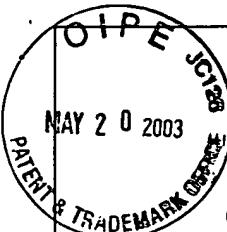
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|-------|---|----|---|----------------------|----------------|
| Sheet | 1 | of | 5 | Attorney Docket No. | 108298515US3 |
| | | | | Application Number | 09/888,002 |
| | | | | Confirmation Number | 9049 |
| | | | | Filing Date | June 21, 2001 |
| | | | | First Named Inventor | Whonchee Lee |
| | | | | Group Art Unit | 3723 |
| | | | | Examiner Name | Dung V. Nguyen |

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| Examiner Initials* | Cite No. | U.S. Patent or Application | | Name of Patentee or Inventor of Cited Document | Date of Publication or Filing Date of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear |
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| | | NUMBER | Kind Code (if known) | | | |
| DVN | | U.S. Application No. 09/651,779 / (Atty. Docket No. 10829.8515US) | | Moore | Filed 08/30/2000 | |
| | | U.S. Application No. 09/651,808 / (Atty. Docket No. 4373US) | | Chopra et al. | Filed 08/30/2000 | |
| | | U.S. Application No. 09/653,392 / (Atty. Docket No. MTI-31044) | | Chopra et al. | Filed 08/31/2000 | |
| | | U.S. Application No. 10/090,869 / (Atty. Docket No. 10829.8544US) | | Moore et al. | Filed 03/04/2002 | |
| | | U.S. Application No. 10/230,463 / (Atty. Docket No. 10829.8672US) | | Lee et al. | Filed 08/29/2002 | |
| | | U.S. Application No. 10/230,602 / (Atty. Docket No. 10829.8674US) | | Chopra | Filed 08/29/2002 | RECEIVED MAY 28 2003 TECHNOLOGY CENTER R3700 |
| | | U.S. Application No. 10/230,628 / (Atty. Docket No. 10829.8673US) | | Lee et al. | Filed 08/29/2002 | |
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| EXAMINER | DATE CONSIDERED |
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| Dung Van Nguyen | 6-13-2003 |

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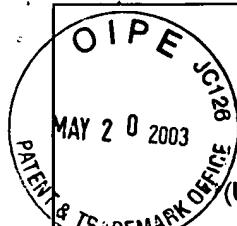
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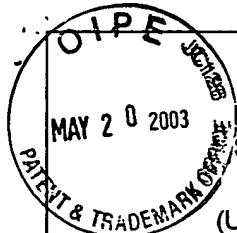
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